

SN54ABT544, SN74ABT544 OCTAL REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS

SCBS189 – FEBRUARY 1991 – REVISED JULY 1993

- State-of-the-Art *EPIC-II B™* BiCMOS Design Significantly Reduces Power Dissipation
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model ($C = 200$ pF, $R = 0$)
- Latch-Up Performance Exceeds 500 mA Per JEDEC Standard JESD-17
- Typical V_{OLP} (Output Ground Bounce) < 1 V at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$
- High-Drive Outputs ($-32\text{-mA } I_{OH}$, $64\text{-mA } I_{OL}$)
- Package Options Include Plastic Small-Outline (SOIC) and Shrink Small-Outline (SSOP) Packages, Ceramic Chip Carriers, and Plastic and Ceramic DIPs

description

The 'ABT544 octal transceiver contains two sets of D-type latches for temporary storage of data flowing in either direction. Separate latch-enable (\overline{LEAB} or \overline{LEBA}) and output-enable (\overline{OEAB} or \overline{OEBA}) inputs are provided for each register to permit independent control in either direction of data flow.

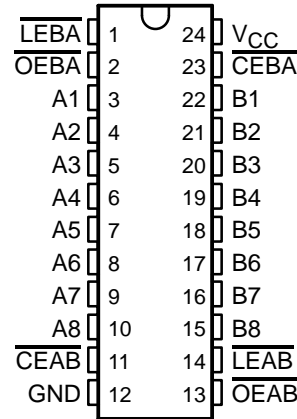
The A-to-B enable (\overline{CEAB}) input must be low in order to enter data from A or to output data from B. If \overline{CEAB} is low and \overline{LEAB} is low, the A-to-B latches are transparent; a subsequent low-to-high transition of \overline{LEAB} puts the A latches in the storage mode. With \overline{CEAB} and \overline{OEAB} both low, the 3-state B outputs are active and reflect the data present at the output of the A latches. Data flow from B to A is similar but requires using the \overline{CEBA} , \overline{LEBA} , and \overline{OEBA} inputs.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

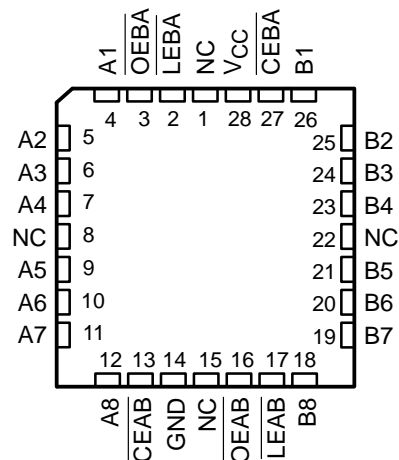
The SN74ABT544 is available in TI's shrink small-outline package (DB), which provides the same I/O pin count and functionality of standard small-outline packages in less than half the printed-circuit-board area.

The SN54ABT544 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74ABT544 is characterized for operation from -40°C to 85°C .

SN54ABT544 . . . JT PACKAGE
SN74ABT544 . . . DB, DW, OR NT PACKAGE
(TOP VIEW)



SN54ABT544 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

PRODUCT PREVIEW

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PRODUCT PREVIEW information concerns products in the formative or design phase of development. Characteristic data and other specifications are design goals. Texas Instruments reserves the right to change or discontinue these products without notice.

 **TEXAS
INSTRUMENTS**

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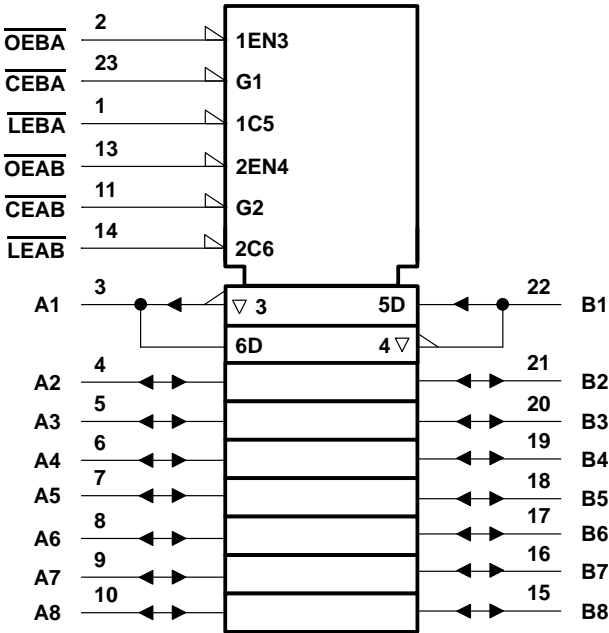
FUNCTION TABLE†

INPUTS				OUTPUT B
CEAB	LEAB	OEAB	A	
H	X	X	X	Z
L	X	H	X	Z
L	H	L	X	B ₀ ‡
L	L	L	L	H
L	L	L	H	L

† A-to-B data flow is shown; B-to-A flow control is the same except that it uses CEBA, LEBA, and OEBA.

‡ Output level before the indicated steady-state input conditions were established.

logic symbol§



§ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the DB, DW, JT, and NT packages.

PRODUCT PREVIEW

SN54ABT544, SN74ABT544

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WITH 3-STATE OUTPUTS

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recommended operating conditions (see Note 2)

			SN54ABT544		SN74ABT544		UNIT
			MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage		4.5	5.5	4.5	5.5	V
V_{IH}	High-level input voltage		2		2		V
V_{IL}	Low-level input voltage			0.8		0.8	V
V_I	Input voltage		0	V_{CC}	0	V_{CC}	V
I_{OH}	High-level output current			–24		–32	mA
I_{OL}	Low-level output current			48		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	Outputs enabled		5		5	ns/V
T_A	Operating free-air temperature		–55	125	–40	85	°C

NOTE 2: Unused or floating pins (input or I/O) must be held high or low.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		T _A = 25°C			SN54ABT544		SN74ABT544		UNIT			
			MIN	TYP†	MAX	MIN	MAX	MIN	MAX				
V _{IK}	V _{CC} = 4.5 V, I _I = –18 mA		–1.2			–1.2		–1.2		V			
V _{OH}	V _{CC} = 4.5 V, I _{OH} = –3 mA		2.5			2.5		2.5		V			
	V _{CC} = 5 V, I _{OH} = –3 mA		3			3		3					
	V _{CC} = 4.5 V, I _{OH} = –24 mA		2			2							
	V _{CC} = 4.5 V, I _{OH} = –32 mA		2‡					2					
V _{OL}	V _{CC} = 4.5 V, I _{OL} = 48 mA		0.55			0.55				V			
	V _{CC} = 4.5 V, I _{OL} = 64 mA		0.55‡					0.55					
I _I	V _{CC} = 5.5 V, V _I = V _{CC} or GND		Control inputs		±1		±1		±1		μA		
			A or B ports		±100		±100		±100				
I _{OZH} §	V _{CC} = 5.5 V, V _O = 2.7 V		50			50		50		μA			
I _{OZL} §	V _{CC} = 5.5 V, V _O = 0.5 V		–50			–50		–50		μA			
I _{off}	V _{CC} = 0, V _I or V _O ≤ 4.5 V		±100					±100		μA			
I _{CEX}	V _{CC} = 5.5 V, V _O = 5.5 V		Outputs high		50		50		50		μA		
I _O ¶	V _{CC} = 5.5 V, V _O = 2.5 V		–50	–100	–180	–50	–180	–50	–180	mA			
I _{CC}	V _{CC} = 5.5 V, I _O = 0, V _I = V _{CC} or GND		A or B ports		Outputs high		1		250		250		μA
					Outputs low		24		34 [#]		34 [#]		mA
					Outputs disabled		0.5		250		250		250
ΔI _{CC}	V _{CC} = 5.5 V, One input at 3.4 V, Other inputs at V _{CC} or GND		1.5			1.5		1.5		mA			
C _i	V _I = 2.5 V or 0.5 V		Control inputs		4						pF		
C _{iO}	V _O = 2.5 V or 0.5 V		A or B ports		7						pF		

† All typical values are at $V_{CC} = 5\text{ V}$.

‡ On products compliant to MIL-STD-883, Class B, this parameter does not apply.

§ The parameters I_{OZH} and I_{OZL} include the input leakage current.

¶ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

This data sheet limit may vary among suppliers.

|| This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

PRODUCT PREVIEW



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